

©2007 Fairchild Semiconductor Corporation FDB8444TS Rev. A (W)

Symbol	Parameter	Rating	s Units
V _{DSS}	Drain to Source Voltage	40	V
V _{GS}	Gate to Source Voltage	±20	V
	Drain Current Continuous (T _C = 140°C, V _{GS} = 10V)	70	
I _D	Continuous (T_{amb} = 25°C, V_{GS} = 10V, with $R_{\theta JA}$ = 43°C/W)	20	A
	Pulsed	See Figu	re 4
E _{AS}	Single Pulse Avalanche Energy (No	e 1) 439	mJ
	Power Dissipation	181	W
P _D	Derate above 25°C	1.2	W/ºC
T _{.I} , T _{STG}	Operating and Storage Temperature	-55 to +1	I75 °C

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance Junction to Case	0.83	°C/W
R_{\thetaJA}	Thermal Resistance Junction to Ambient TO-263, 1in ² copper pad area	43	°C/W

Package Marking and Ordering Information

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Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB8444TS	FDB8444TS	TO-263 5LDS	330mm	24mm	800 units

Electrical Characteristics T_{C} = 25°C unless otherwise noted

	Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
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Off Characteristics

B _{VDSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS}	$I_{D} = 250 \mu A, V_{GS} = 0V$		-	-	V
1	Zero Gate Voltage Drain Current	V _{DS} = 32V,		-	-	1	
IDSS Zero Gale Volta	Zero Gale Vollage Drain Current	$V_{GS} = 0V$	T _C = 150°C	-	-	250	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2	2.8	4	V
		I _D = 70A, V _{GS} = 10V	-	3.8	5	
r _{DS(on)}	Drain to Source On Resistance	$I_D = 70A, V_{GS} = 10V, T_J = 175^{\circ}C$	-	6.5	8.5	mΩ

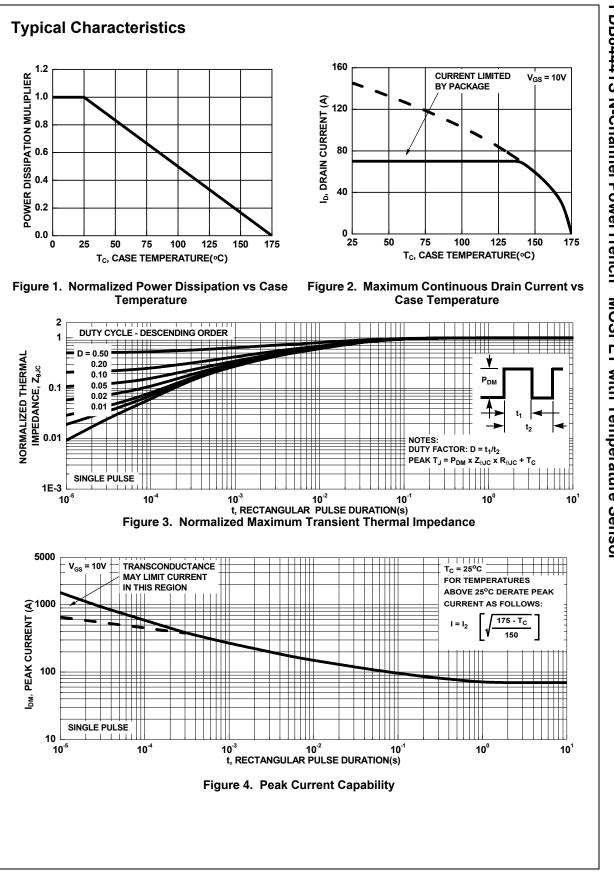
Dynamic Characteristics

C _{iss}	Input Capacitance		2) (-	8410	-	pF
C _{oss}	Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		-	765	-	pF
C _{rss}	Reverse Transfer Capacitance			-	485	-	pF
R _G	Gate Resistance	f = 1MHz		-	1.8	-	Ω
Q _{g(TOT)}	Total Gate Charge at 20V	V _{GS} = 0 to 20V		-	260	338	nC
Q _{g(10)}	Total Gate Charge at 10V	V _{GS} = 0 to 10V		-	130	169	nC
Q _{g(TH)}	Threshold Gate Charge	V_{GS} = 0 to 2V	V _{DD} = 20V	-	15.5	-	nC
Q _{gs}	Gate to Source Gate Charge		I _D = 70A	-	33	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau			-	17.7	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			-	30	-	nC

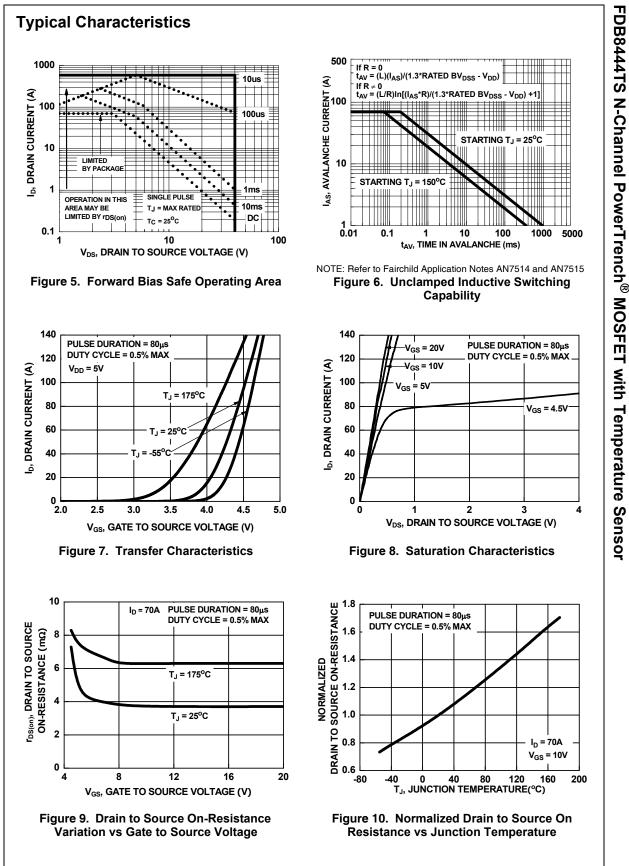
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Switch	ing Characteristics		L			
t _{on}	Turn-On Time		-	-	96	ns
t _{d(on)}	Turn-On Delay Time		-	14.6	-	ns
t _r	Rise Time	$V_{DD} = 20V, I_D = 70A$	-	19.1	-	ns
t _{d(off)}	Turn-Off Delay Time	$-V_{GS}$ = 10V, R_{GS} = 2 Ω	-	44	-	ns
t _f	Fall Time		-	17.3	-	ns
t _{off}	Turn-Off Time		-	-	98	ns
V _{SD}	Source to Drain Diode Voltage	I _{SD} = 70A I _{SD} = 40A	-	1.0 0.9	1.25 1.0	V
V _{SD}	Source to Drain Diode Voltage	-	-	0.9	1.0	V
t _{rr}	Reverse Recovery Time	— I _{SD} = 70A, dI _{SD} /dt = 100A/μs	-	51	66	ns
Q _{rr}	Reverse Recovery Charge	$ISD = 70$ Å, $ISD/III = 100$ Å μ S	-	70	91	nC
V _f	Temperature Sense Diode Voltage	I _f = 1mA	1.58	1.61	1.63	V
S _f	Temperature Sense Diode Temperature Coefficient	I _f = 1mA, -55 ^o C < T _J < 175 ^o C	-2.55	-2.74	-3.11	mV/ºC
Notes: 1: Starting T _J	= 25 ^o C, L = 0.28mH, I _{AS} = 56A.					

This product has been designed to meet the extreme test conditions and environment demanded by the automotive industry. For a copy of the requirements, see AEC Q101 at: http://www.aecouncil.com/ All Fairchild Semiconductor products are manufactured, assembled and tested under ISO9000 and QS9000 quality systems

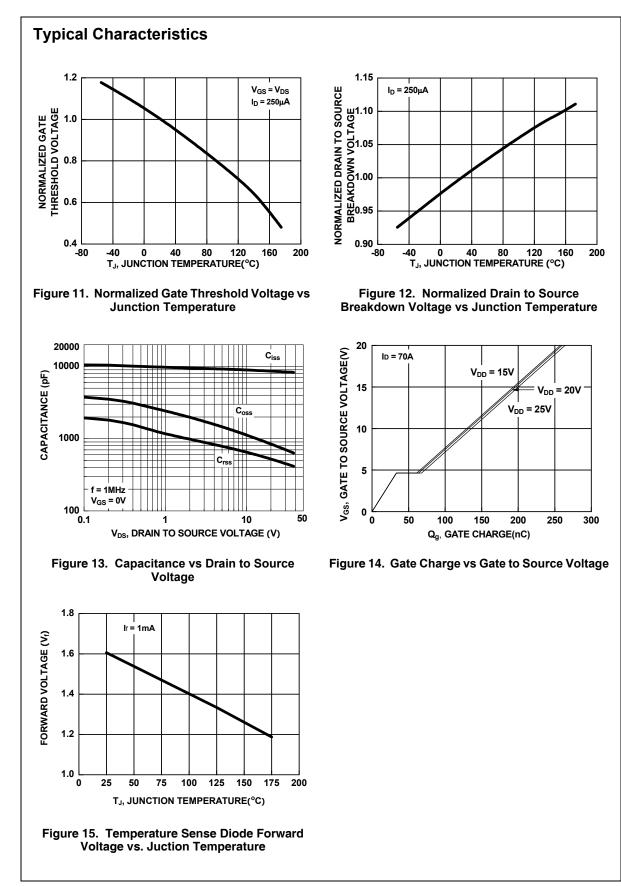
certification.



FDB8444TS N-Channel PowerTrench[®] MOSFET with Temperature Sensor



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